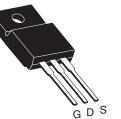
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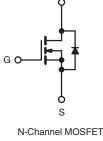


Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	60			
R _{DS(on)} (Ω)	$V_{GS} = 5.0 V$	0.050		
Q _g (Max.) (nC)	35			
Q _{gs} (nC)	7.1			
Q _{gd} (nC)	25			
Configuration	Single			







FEATURES

f = 60 Hz)

Isolated Package

RoHS

COMPLIANT

Sink to Lead Creepage Distance 4.8 mm

• High Voltage Isolation = 2.5 kV_{RMS} (t = 60 s;

- · Logic-Level Gate Drive
- $R_{DS(on)}$ Specified at $V_{GS} = 4 V$ and 5 V
- · Fast Switching
- · Ease of paralleling
- · Lead (Pb)-free

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 FULLPAK eliminates the need for additional insulating hardware in commercial-industrial applications. The molding compound used provides a high isolation capability and a low thermal resistance between the tab and external heatsink. This isolation is equivalent to using a 100 micron mica barrier with standard TO-220 product. The FULLPAK is mounted to a heatsink using a single clip or by a single screw fixing.

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free	IRLIZ34GPbF
	SiHLIZ34G-E3
SnPb	IRLIZ34G
	SiHLIZ34G

ABSOLUTE MAXIMUM RATINGS $T_C = 25 ^{\circ}C$, unless otherwise noted						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	60	v		
Gate-Source Voltage			V _{GS}	± 10	v	
Continuous Drain Current	V _{GS} at 5.0 V	V_{GS} at 5.0 V $\begin{array}{c} T_{C} = 25 \text{ °C} \\ T_{C} = 100 \text{ °C} \end{array}$	I _D	20		
	VGS at 5.0 V	T _C = 100 °C		14	A	
Pulsed Drain Current ^a			I _{DM}	80		
Linear Derating Factor			0.28	W/°C		
Single Pulse Avalanche Energy ^b			E _{AS}	200	mJ	
Maximum Power Dissipation	T _C = 25 °C		P _D 42		W	
Peak Diode Recovery dV/dt ^c			dV/dt 4.5		V/ns	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 175	°C		
Soldering Recommendations (Peak Temperature)	for 10 s			300 ^d		
Mounting Torque	6-32 or M3 screw			10	lbf ⋅ in	
				1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. $V_{DD} = 25 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 583 µH, $R_G = 25 \Omega$, $I_{AS} = 20 \text{ A}$ (see fig. 12c). c. $I_{SD} \leq 30 \text{ A}$, dl/dt $\leq 200 \text{ A/µs}$, $V_{DD} \leq V_{DS}$, $T_J \leq 175 \text{ °C}$.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RA	TINGS								
PARAMETER	SYMBOL	TYP. MAX. - 65			UNIT				
Maximum Junction-to-Ambient	R _{thJA}					°C/M			
Maximum Junction-to-Case (Drain)	R _{thJC}	-		3.6		°C/W			
SPECIFICATIONS $T_J = 25 °C$,	unless otherw	vise noted							
PARAMETER	SYMBOL	1		ONS	MIN.	TYP.	MAX.		
Static								<u> </u>	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA			60	- 1	- 1	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$		e to 25 °C,	-	-	0.070	-	V/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	4	: V _{GS} , I _D = 2		1.0	-	2.0	v	
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 10^{\circ}$		-	-	± 100	nA	
	000	$V_{\rm DS} = 60 \text{ V}, \text{ V}_{\rm GS} = 0 \text{ V}$		-	-	25			
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 48 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 150 \text{ °C}$			-	-	250	μA	
Drain-Source On-State Resistance		V _{GS} = 5.0 V		= 12 A ^b	-	-	0.050		
	R _{DS(on)}	V _{GS} = 4.0 V	5	= 10 A ^b	-	-	0.070	Ω	
Forward Transconductance	g _{fs}	$V_{DS} = 25 V, I_D = 12 A^b$		12	-	-	S		
Dynamic	513		- , 0						
Input Capacitance	C _{iss}				-	1600	-		
Output Capacitance	C _{oss}	$V_{GS} = 0 V, V_{DS} = 25 V, f = 1.0 MHz, see fig. 5 f = 1 MHz$		-	660	-	рF		
Reverse Transfer Capacitance	C _{rss}			-	170	-			
Drain to Sink Capacitance	C			-	12	-			
Total Gate Charge	Qg			-	-	35			
Gate-Source Charge	Q _{gs}	V _{GS} = 5.0 V	$I_D = 30$ Å	$_{\rm D} = 30$ A, $V_{\rm DS} = 48$ V,	-	-	7.1	nC	
Gate-Drain Charge	Q _{gd}	$v_{GS} = 5.0 v$ see fig. 6 and 13 ^b		J. 6 anu 13º	-	-	25		
Turn-On Delay Time	t _{d(on)}				-	14	-		
Rise Time	t _r		= 30 V, I _D =		-	170	-	1	
Turn-Off Delay Time	t _{d(off)}	$R_G = 6.0 \Omega, R_D = 1.0 \Omega,$ see fig. 10 ^b		-	30	-	ns		
Fall Time	t _f			-	56	-			
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	nH		
Internal Source Inductance	L _S			-	7.5	-			
Drain-Source Body Diode Characteristic	cs				1	1	1	Į	
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	20	A		
Pulsed Diode Forward Currenta	I _{SM}			-	-	80			
Body Diode Voltage	V _{SD}	$T_J = 25 \ ^{\circ}C, \ I_S = 20 \ A, \ V_{GS} = 0 \ V^b$		-	-	1.6	V		
Body Diode Reverse Recovery Time	t _{rr}	$T_{\rm J} = 25 \ ^{\circ}\text{C}, \ I_{\rm F} = 30 \ \text{A}, \ \text{dl/dt} = 100 \ \text{A}/\mu\text{s}^{\rm b}$		-	90	180	ns		
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.65	1.3	μC		
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L _S and L)		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

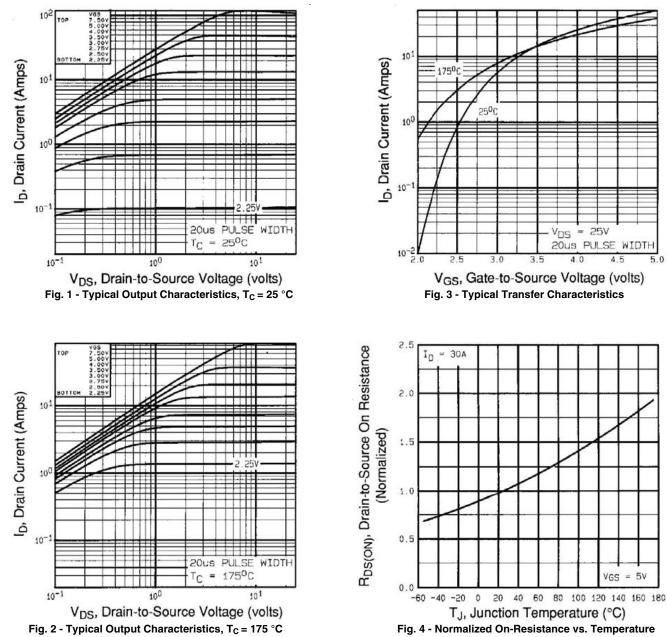
b. Pulse width \leq 300 µs; duty cycle \leq 2 %.



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5.0





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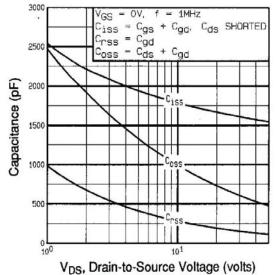


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

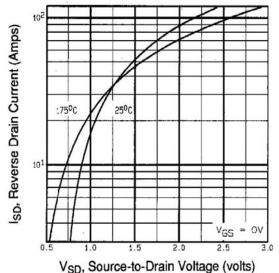


Fig. 7 - Typical Source-Drain Diode Forward Voltage

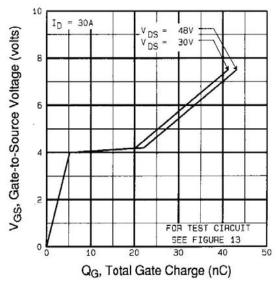
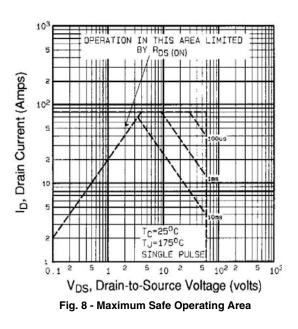


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage





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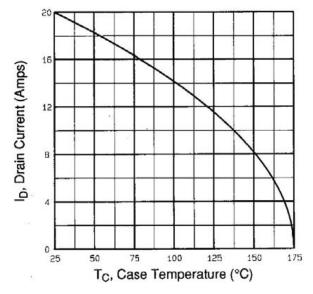


Fig. 9 - Maximum Drain Current vs. Case Temperature

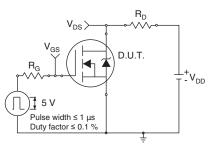


Fig. 10a - Switching Time Test Circuit

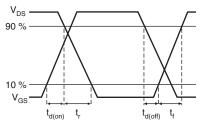
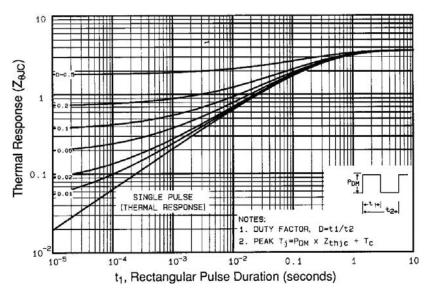


Fig. 10b - Switching Time Waveforms





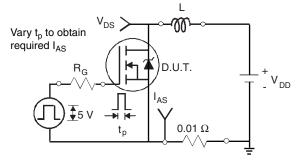


Fig. 12a - Unclamped Inductive Test Circuit

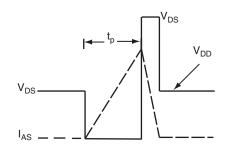
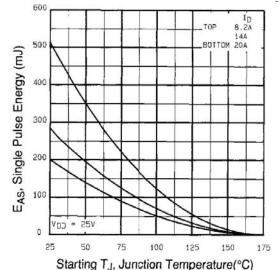


Fig. 12b - Unclamped Inductive Waveforms

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Starting T_J, Junction Temperature(°C) Fig. 12c - Maximum Avalanche Energy vs. Drain Current

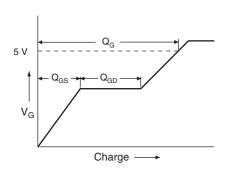


Fig. 13a - Basic Gate Charge Waveform

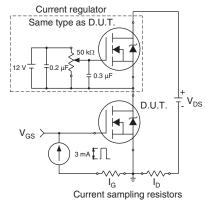
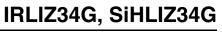
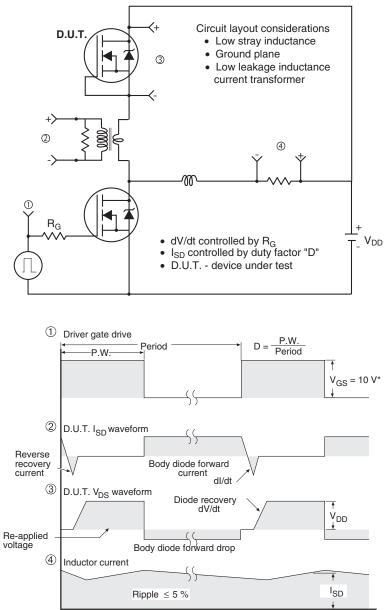


Fig. 13b - Gate Charge Test Circuit



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Peak Diode Recovery dV/dt Test Circuit

* V_{GS} = 5 V for logic level devices and 3 V drive devices

Fig. 14 - For N-Channel

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